

S.P.K. Electronics Co., Ltd.

GPS module Spec

REV 005

Revision	Pages	Description	Ву	Date
0.004	5	1. GPS module change from S type to SL1206	Chris Yeh	2009/4/16

Parameter	Specification			
1. Chip Set	uBlox 5			
2. Antenna	Sarantel SL1206			
	Frequency: 1575.42Mhz			
	Gain: +24 dBic			
	Beamwidth: > 120 Degrees			
	Noise Figure: 1.2 dB			
3. Receiver Type	50 Channel			
	GPS L1 frequency, C/A Code			
	GALILEO Open Service L1 frequency			
4. Time to First Fix	Cold Start (Autonomous)	29s		
	Warm Start (Autonomous)	29s		
	Hot Start (Autonomous)	<1s		
	Aided Starts	<1s		
5. Sensitivity	Tracking & Navigation	<-160dBm		
	Reacquisition	<-160dBm		
	Cold Start (Autonomous)	<-144dBm		
6. Horizontal Position	Autonomous	<2.5m		
	SBAS	<2.0m		
7. Accuracy of Timepulse Signal	RMS	30ns		
	99%	<60ns		
8. Max Navigation Update Rate		4Hz		
9. Velocity Accuracy	0.1m/s	0.1m/s		
10. Heading Accuracy	0.5 degrees	0.5degress		
11. Dynamics	Weight	<15g		
12. Power	3.3V +- 5% DC input , < 50mVpp			
13. Interface	Baud Rate	9600		
	Level	TTL		
	Connector Type: Panasonic AXK6F10547YG			
14. Environmental	Operating Temp	-10~50°C		
15. Flash	Size	4Mbit		

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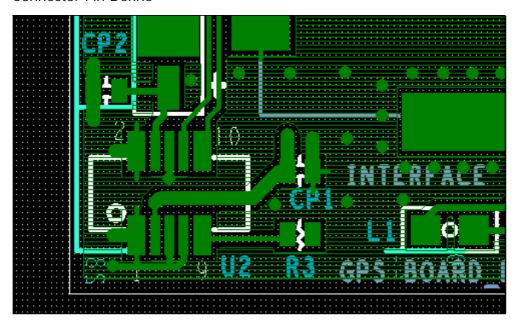
10F, No. 510, Sec. 5, Chung Hsiao E, RD., Taipei Taiwan, 110

TEL: 886-2-2346-2323 FAX: 886-2-2346-3939

E-mail Address: spk@spkecl.com

Web Site: http://www.spkecl.com

Connector Pin Define



NO	Name	1/0	Note
1	GND1		Ground
2	GND4		Ground
3	VIN		Power Input, 3.3V +- 5%, < 50mVpp
4	BATTERY		Backup Battery power input, for data backup
5	GND2		Ground
6	GND5		Ground
7	GND3		Ground
8	RX	0	Connect to CPU RX (input)
9	GPIO1		NC.
10	TX	l	Connect to CPU TX (output)

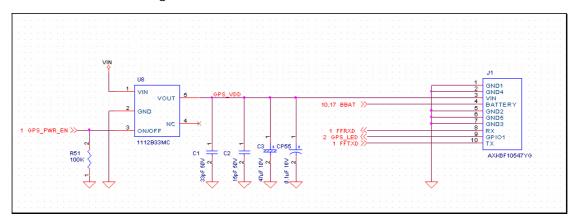
- I/O defines for module. 1
- 2 BATTERY input range 1.6V ~ 5.1V.
- 3 GPS receivers require a stable power supply, avoid ripple on VIN (<50mVpp)
- Connector Type
 - 4.1 On Module => Panasonic AXK6F10547YG
 - 4.2 On Device => Panasonic AXK5F10547YG

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TEL: 886-2-2346-2323 FAX: 886-2-2346-3939 E-mail Address: spktw@ms34.hinet.net; spk@spkecl.com

Reference Circuit Design



1. U8

1.1 Manufacturer: EPSON

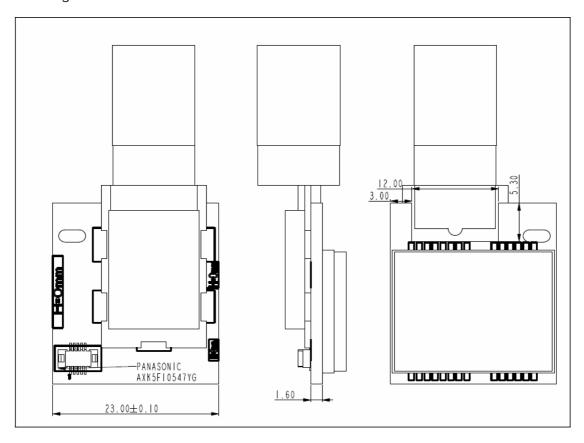
1.2 Part number: S-1112B30MC

2 BBAT connect to Backup Battery (Voltage range 1.6V ~ 5.1V).

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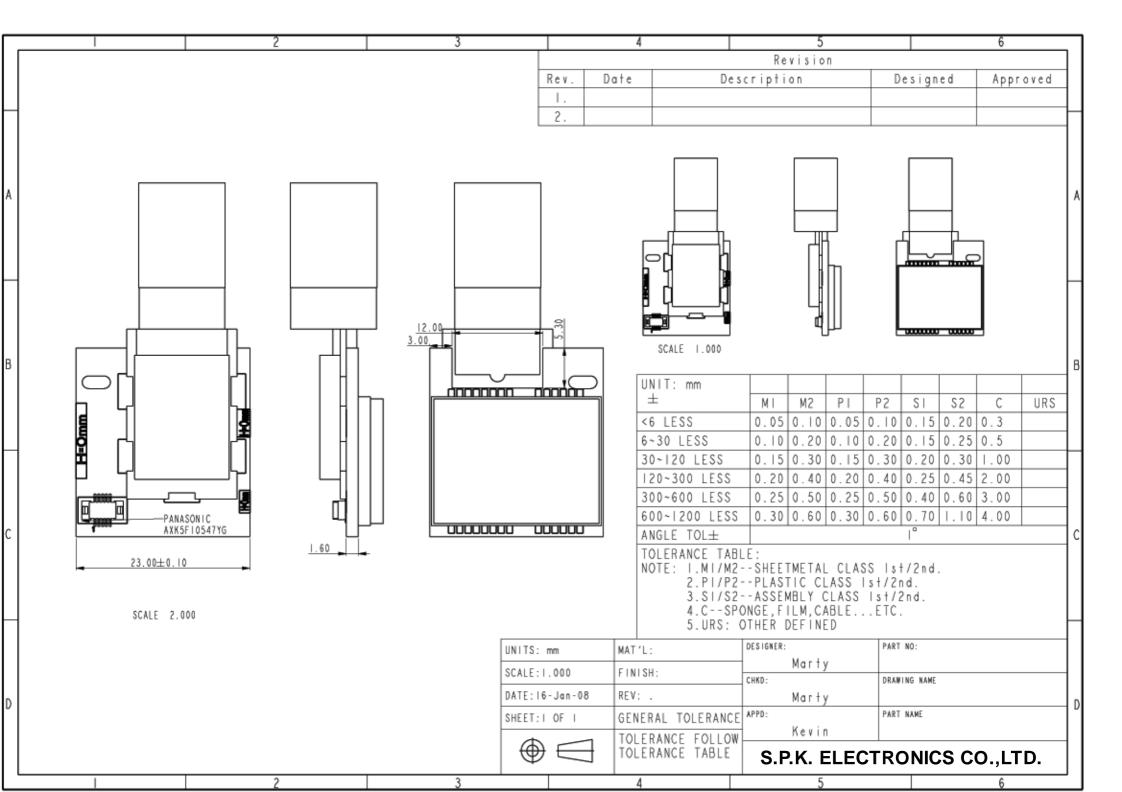
Drawing

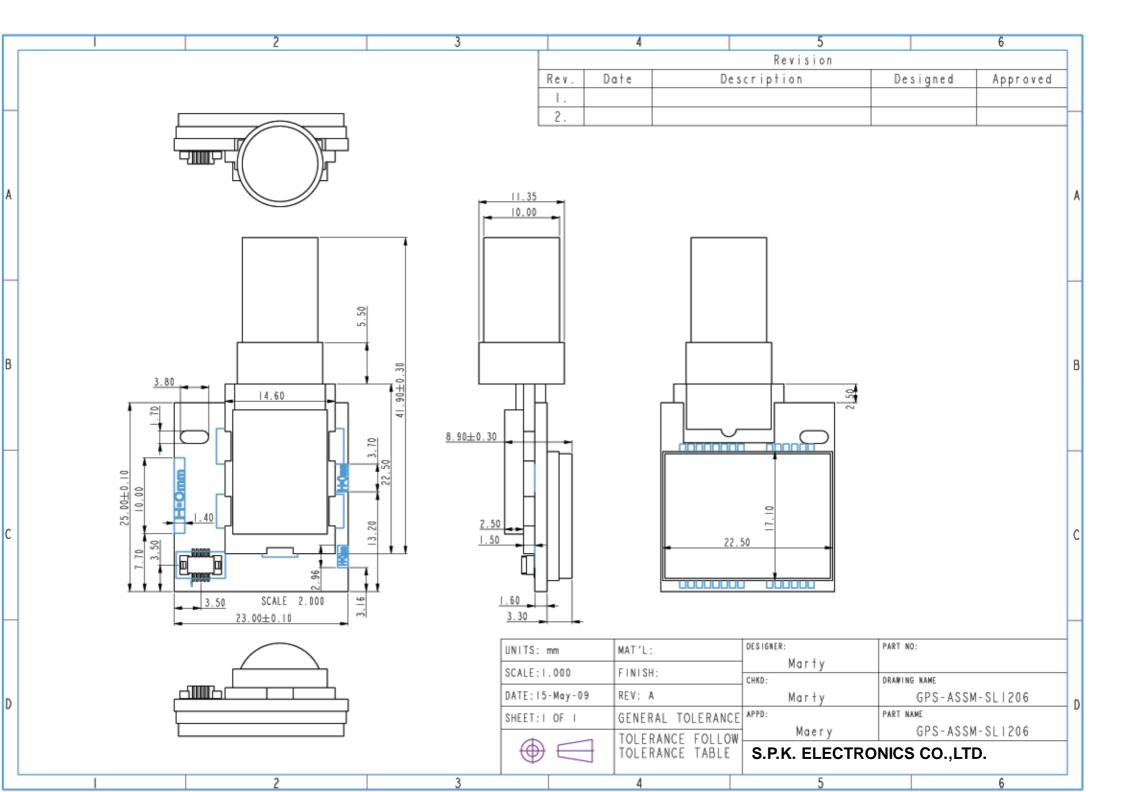


1 Please check "drawing_SL1206.zip" file for detail 3D file (DXF format)

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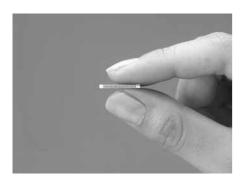
 $E\text{-mail Address: } \underline{spktw@ms34.hinet.net} \; ; \underline{spk@spkecl.com}$





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ideas for life





Compliance with RoHS Directive

FEATURES

1. The connector is a two-piece structure and 0.5mm pitch.

The product lineup consists of the mated height of 1.5mm, 2.0mm and 2.5mm.

2. Strong resistance to adverse environments! Utilizes

TDUGH CONTRET construction for high contact reliability.

1) The socket and header has the same dropping shock and torsion resistant construction as the bellows-type contact.



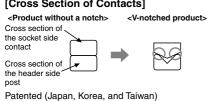
Since the contact is formed by bending thin plate, it has a spring-like quality This construction helps make it resistant to dropping and twisting

2) V notch construction used for excellent resistance against foreign matters.

V-notch

By making contact with the edges and thus increasing the contact pressure, this product can eliminate flux and other foreign matters more effectively than conventional products, which also helps to prevent foreign matters from obstructing the contact.

[Cross Section of Contacts]

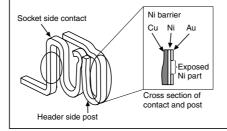


NARROW-PITCH CONNECTORS FOR BOARD-TO-BOARD CONNECTION

3) Use of Ni barrier construction is standard. Highly effective against solder creeping. (Available from Oct. 2005)

Ni barrier

The exposed nickel-plated portion of the gold-plated contact prevents solder creep despite the ultra low profile of the contact.



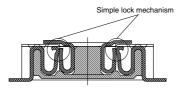
4) Porosity treatment applied for improved resistance against corrosion.

Porosity treatment

This treatment consists in coating the surface with a very thin film to seal pinholes in the gold plating. We have developed this porosity treatment technology, which ensures contact reliability for thin gold plating comparable to that of thick gold plating.

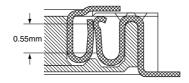
Porosity treatment film Ambient gas Au plating Ni plating Base material

- Improvement in insertion/removal durability
- Improvement in resistance to corrosion
- Improvement in contact reliability for digital signals
- 3. Simple locking structure Superior mating operation with click feel to indicate that mating is complete.



4. Mating length 0.55mm

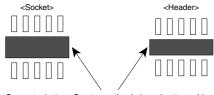
While achieving a low profile of 1.5mm between PCBs, the effective mating length has been extended to ensure that there is some latitude in the mating.



NARROW PITCH (0.5mm) CONNECTORS P5 SERIES — P5KF-

5. The lower connector bottom surface construction prevents contact and shorts between the PCB and metal terminals.

This enables freedom in pattern wiring, helping to make PCB's smaller.



Connector bottom: Create any thru-hole and pattern wiring.

- 6. Automatic mounting inspection is facilitated by the gull-wing terminal shape which makes mounting verification easy.
- 7. Connectors for inspection available Connectors for inspection are available that are ideal for modular unit inspection and inspection in device assembly processes.

APPLICATIONS

Compact portable devices "Cellular phones, DVC, Digital cameras, etc"

Ideal for Board-to-FPC connections

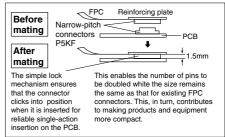


TABLE OF PRODUCT TYPES

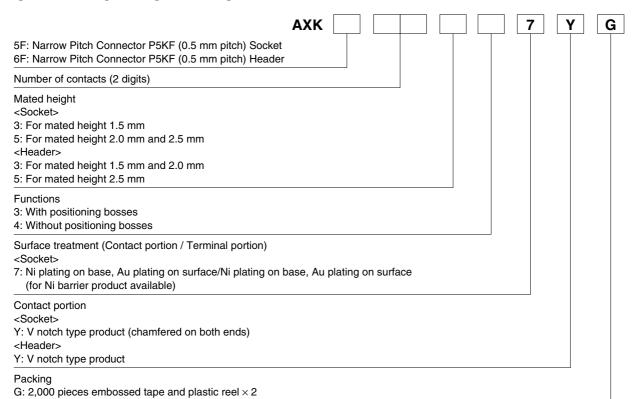


Product name		P5KF				
Mated height		1.5mm	2.0mm	2.5mm		
	10	☆	☆	☆		
	12	☆	☆	☆		
	14	☆	☆	☆		
	16	☆	☆	☆		
	18	☆	☆	☆		
	20	公	☆	☆		
Number of contacts	22	☆	☆	☆		
	24	☆	☆	☆		
	26	☆	☆			
j c	30	☆	☆	☆		
er 0	32	☆				
ηρe	34	☆	☆	☆		
Nur	36			☆		
	40	☆	☆	☆		
	44			☆		
	50	☆	☆	☆		
	60	☆	☆	☆		
	70	☆	☆	☆		
	80	☆	☆	☆		
	100		☆	☆		

Notes: 1. The standard type comes without positioning bosses.

Connectors with positioning boss are available for on-demand production. 2. Please consult us for products which have no \dot{x} mark.

ORDERING INFORMATION



AXK(5/6)F

PRODUCT TYPES

		Part No.		Packing		
Mated height	No. of contacts	Socket	Header	Inner corten (1 real)	Outer certen	
		TOUGH CONTACT	TOUGH CONTRCT	Inner carton (1-reel)	Outer carton	
	10	AXK5F10347YG	AXK6F10347YG			
	12	AXK5F12347YG	AXK6F12347YG			
	14	AXK5F14347YG	AXK6F14347YG			
	16	AXK5F16347YG	AXK6F16347YG			
	18	AXK5F18347YG	AXK6F18347YG			
	20	AXK5F20347YG	AXK6F20347YG			
	22	AXK5F22347YG	AXK6F22347YG			
	24	AXK5F24347YG	AXK6F24347YG			
1.5 mm	26	AXK5F26347YG	AXK6F26347YG			
	30	AXK5F30347YG	AXK6F30347YG			
	32	AXK5F32347YG	AXK6F32347YG			
	34	AXK5F34347YG	AXK6F34347YG			
	40	AXK5F40347YG	AXK6F40347YG			
	50	AXK5F50347YG	AXK6F50347YG			
	60	AXK5F60347YG	AXK6F60347YG			
	70	AXK5F70347YG	AXK6F70347YG			
	80	AXK5F80347YG	AXK6F80347YG			
	10	AXK5F10547YG	AXK6F10347YG			
	12	AXK5F12547YG	AXK6F12347YG			
	14	AXK5F14547YG	AXK6F14347YG			
	16	AXK5F16547YG	AXK6F16347YG			
	18	AXK5F18547YG	AXK6F18347YG			
	20	AXK5F20547YG	AXK6F20347YG			
	22	AXK5F22547YG	AXK6F22347YG			
	24	AXK5F24547YG	AXK6F24347YG			
2.0 mm	26	AXK5F26547YG	AXK6F26347YG	2,000 pieces	4,000 pieces	
	30	AXK5F30547YG	AXK6F30347YG			
	34	AXK5F34547YG	AXK6F34347YG			
	40	AXK5F40547YG	AXK6F40347YG			
	50	AXK5F50547YG	AXK6F50347YG			
	60	AXK5F60547YG	AXK6F60347YG			
	70	AXK5F70547YG	AXK6F70347YG			
	80	AXK5F80547YG	AXK6F80347YG			
	100	AXK5F00547YG	AXK6F00347YG			
	10	AXK5F10547YG	AXK6F10547YG			
	12	AXK5F12547YG	AXK6F12547YG			
	14	AXK5F14547YG	AXK6F14547YG			
	16	AXK5F16547YG	AXK6F16547YG			
	20	AXK5F20547YG	AXK6F20547YG			
	22	AXK5F22547YG	AXK6F22547YG			
	24	AXK5F24547YG	AXK6F24547YG			
	30	AXK5F30547YG	AXK6F30547YG			
2.5 mm	34	AXK5F34547YG	AXK6F34547YG			
	36	AXK5F36547YG	AXK6F36547YG			
	40	AXK5F40547YG	AXK6F40547YG			
	44	AXK5F44547YG	AXK6F44547YG			
	50	AXK5F50547YG	AXK6F50547YG			
	60	AXK5F60547YG	AXK6F60547YG			
	70	AXK5F70547YG	AXK6F70547YG			
	80	AXK5F80547YG	AXK6F80547YG			
				_		

Notes: 1. Regarding ordering units, During production: Please make orders in 1-reel units. Samples for mounting confirmation: Available in units of 50 pieces. Please consult us. (See "Regarding sample orders to confirm proper mounting" on page 19.) Samples: Small lot orders are possible. Please consult us.

2. The standard type comes without positioning bosses. Connectors with positioning bosses are available for on-demand production. For this type of connector, 9th

digit of the part no. changes from 4 to 3. e.g. Mated height 1.5mm, 10 contacts for sockets: AXK5F10337YG

3. The 11th digit "Y" in the socket/header part number indicates the connector has a V notch. (For details, please consult one of our sales offices.)

4. Previous non-TDUSH CONTACT types and current TDUSH CONTACT types are compatible for mating.

SPECIFICATIONS

1. Characteristics

Item			Specifications	Conditions		
	Rated current	0.5A/con	tact (Max. 10 A at total contacts)			
Electrical	Rated voltage	60V AC/DC				
	Breakdown voltage	150V AC for 1 minute		Detection current: 1mA		
characteristics	Insulation resistance		Min. 1,000MΩ (initial)	Using 500V DC megger		
	Contact resistance		Max. 90m $Ω$	Based on the contact resistance measurement method specified by JIS C 5402.		
Maril and and	Composite insertion force	Max. 0.9	81N/contacts × contacts (initial)			
Mechanical characteristics	Composite removal force	Min.	0.0588N/contacts × contacts			
Characteristics	Post holding force		Min. 0.981N/contact	Measures the maximum load in the post axial direction until removal		
	Ambient temperature	−55°C to +85°C		No freezing at low temperatures		
	Soldering heat resistance	Max. peak temperature of 260°C (on the surface of the PC board around the connector terminals)		Infrared reflow soldering		
		300°C within 5 seconds, 350°C within 3 seconds		Soldering iron		
Environmental characteristics	Thermal shock resistance (header and socket mated)	5 cycles,	insulation resistance min. 100M $\!\Omega,$ contact resistance max. $90 m \Omega$	Sequence 155.\(\frac{9}{3}\)°C, 30 minutes 2. \(\times\), Max. 5 minutes 3. 85'\(\frac{9}{3}\)°C, 30 minutes 4. \(\times\), Max. 5 minutes		
	Humidity resistance (header and socket mated)	120 hours,	insulation resistance min. 100M Ω , contact resistance max. 90m Ω	Bath temperature 40±2°C, humidity 90 to 95% R.H.		
	Saltwater spray resistance (header and socket mated)	24 hours,	insulation resistance min. 100M Ω , contact resistance max. 90m Ω	Bath temperature 35±2°C, saltwarter concentration 5±1%		
	H ₂ S resistance (header and socket mated)	48 hours,	contact resistance max. $90m\Omega$	Bath temperature 40±2°C, gas concentration 3±1 ppm, humidity 75 to 80% R.H.		
Lifetime characteristics	Insertion and removal life	50 times		Repeated insertion and removal speed of max. 200 times/hours		
Unit weight		Mated height Header: 0.04	1.5mm, 20 contacts; Socket: 0.06g			

2. Material and surface treatment

Part name	Material	Surface treatment
Molded portion	LCP resin (UL94V-0)	_
Contact/Post	Copper alloy	Contact portion: Ni plating on base, Au plating on surface Terminal portion: Ni plating on base, Au plating on surface (Except for thick of terminal) The section close to the soldering portion has a nickel barrier. (The nickel base is exposed.)

DIMENSIONS (Unit: mm)

The CAD data of the products with a CAD Data mark can be downloaded from: http://www.mew.co.jp/ac/e

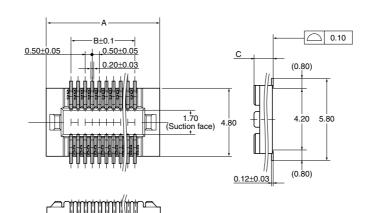
• Socket (Mated height: 1.5mm, 2.0mm, 2.5mm)

CAD Data



Dimension table (mm)

No. of contacts	А	В
10	5.50	2.00
12	6.00	2.50
14	6.50	3.00
16	7.00	3.50
18	7.50	4.00
20	8.00	4.50
22	8.50	5.00
24	9.00	5.50
26	9.50	6.00
30	10.50	7.00
32	11.00	7.50
34	11.50	8.00
36	12.00	8.50
40	13.00	9.50
44	14.00	10.50
50	15.50	12.00
60	18.00	14.50
70	20.50	17.00
80	23.00	19.50
100	28.00	24.50



General tolerance: ±0.2

Mated height	С
1.5 mm	1.35
2.0 mm, 2.5 mm	1.85

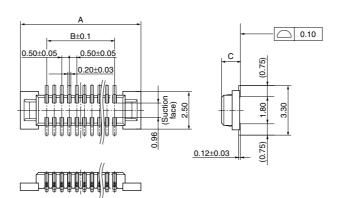
• Header (Mated height: 1.5mm, 2.0mm, 2.5mm)

CAD Data



Dimension table (mm)

No. of contacts	А	В
10	5.50	2.00
12	6.00	2.50
14	6.50	3.00
16	7.00	3.50
18	7.50	4.00
20	8.00	4.50
22	8.50	5.00
24	9.00	5.50
26	9.50	6.00
30	10.50	7.00
32	11.00	7.50
34	11.50	8.00
36	12.00	8.50
40	13.00	9.50
44	14.00	10.50
50	15.50	12.00
60	18.00	14.50
70	20.50	17.00
80	23.00	19.50
100	28.00	24.50

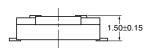


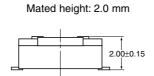
General tolerance: ±0.2

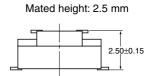
Mated height	С
1.5 mm, 2.0 mm	1.25
2.5 mm	1.75

· Socket and header are mated

Mated height: 1.5 mm







EMBOSSED TAPE DIMENSIONS (unit: mm, Common for respective contact type, socket and header)

- Tape dimensions (Conforming to JIS C 0806-1990. However, some tapes have mounting hole pitches that do not comply with the standard.)
- Plastic reel dimensions (Conforming to EIAJ ET-7200B)

Tape I

A±0.3

C

1.75

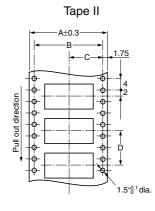
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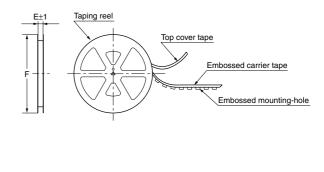
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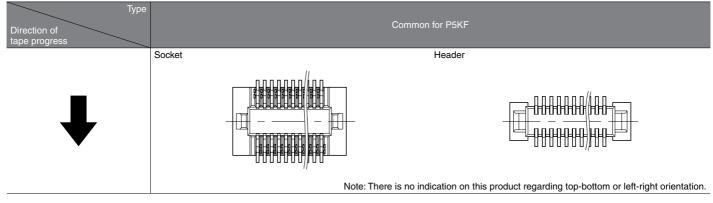


Dimension table (mm)

Suffix: G (1 reel, 2,000 pieces embossed tape: Plastic reel package)

Mated height	No. of contacts	Type of taping	А	В	С	D		F	Quantity per reel
Socket and header are common: 1.5mm, 2.0mm, 2.5mm	10 to 58	Tape I	24.0	_	11.5	12.0	25.4	380 dia.	2,000 pcs.
	60 to 70	Tape II	32.0	28.4	14.2	12.0	33.4	380 dia.	2,000 pcs.
	72 to 100	Tape II	44.0	40.4	20.2	12.0	45.4	380 dia.	2,000 pcs.

Connector orientation with respect to direction of progress of embossed tape



Panasonic ideas for life

CONNECTOR FOR INSPECTION USAGE APPLICATIONS WITH 3,000 INSERTION AND REMOVAL TIMES

NARROW PITCH CONNECTOR P5KF (0.5 mm PITCHES) FOR INSPECTION USAGE





Socket

Header

Compliance with RoHS Directive

FEATURES

1. 3,000 insertion and removals (when as recommended)

From the 50 insertion and removals of standard type, up to 3,000 insertion and removals (with recommended insertion and removal) are possible for use in inspection.

Ideal for inspection of module units and inspection during the device assembly process

2. Same external dimensions and foot pattern as standard type.

Since shape is the same as standard type, inspection is possible without interfering with devices in the vicinity of standard connectors.

3. Improved mating

Insertion and removal have become easier due to a reduction in the mating retention force required by the simple locking structure and also in the amount of force needed for insertion and removal. (We cannot warrant anything regarding mating retention.)

TABLE OF PRODUT TYPES

☆: Available for sale

Product		P5KF for		
name		inspection		
Number of contacts	10	☆		
	12	☆		
	14	☆		
	16	☆		
	18	☆		
	20	☆		
	22	☆		
	24	☆		
	26	☆		
	30	☆		
	32	☆		
	34	☆		
	40	☆		
	50	☆		
	60	☆		
	70	☆		
	80	☆		
	100	☆		

Notes:

- 1. You can use with each mated height in common.
- 2. Please inquire about numbers of contacts other than those given above.
- 3. Please inquire with us regarding delivery times.
- 4. Please keep the minimum unit for ordering no less than 50 pieces per lot.
- 5. Please inquire for further information.

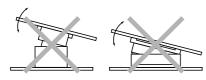
PRODUCT TYPES

Specifications		Part No.	Specifications		Part No.
Socket	With positioning bosses	AXK5FE**36G	AXK5FE**36G Header	With positioning bosses	AXK6FE**36G
	Without positioning bosses	ithout positioning bosses AXK5FE**46G		Without positioning bosses	AXK6FE**46G

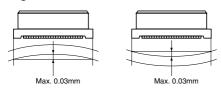
Note: When placing an order, substitute the "*" (asterisk) in the above part number with the number of contacts for the required connector.

NOTES

1. As shown below, excess force during insertion may result in damage to the connector or removal of the solder. Please be careful. Also, to prevent connector damage please confirm the correct position before mating connectors.



2. Keep the PC board warp no more than 0.03 mm in relation to the overall length of the connector.

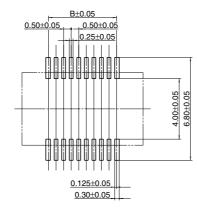


3. PC Boards and Recommended Metal Mask Patterns

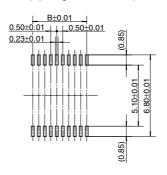
Connectors are mounted with high density, with a pitch interval of 0.4 to 0.5 mm. It is therefore necessary to make sure that the right levels of solder are used, in order to reduce solder bridge and other issues. The figures to the right are recommended metal mask patterns. Please use them as a reference.

Socket

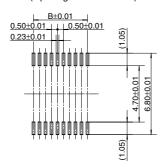
Recommended PC board pattern (TOP VIEW)



Recommended metal mask pattern Metal mask thickness: Here, 150 μm (Opening area ratio: 56%)

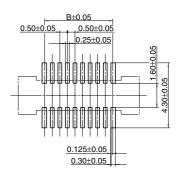


Recommended metal mask pattern Metal mask thickness: Here, 120 μm (Opening area ratio: 69%)

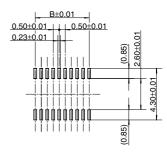


• Header

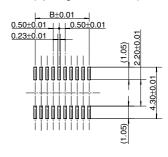
Recommended PC board pattern (TOP VIEW)



Recommended metal mask pattern Metal mask thickness: Here, 150 μm (Opening area ratio: 58%)



Recommended metal mask pattern Metal mask thickness: Here, 120 μm (Opening area ratio: 72%)



^{*} See the dimension table on page 82 for more information on the B dimension of the socket and header.

For other details, please verify with the product specification sheets.